

G65SCXX Series G65SC1XX Series

Microcircuits

CMOS G65SCXXX 8-Bit Microprocessor Family

Features

- CMOS family that is compatible with NMOS 6500 series microprocessors
- Uses single +5 volt power supply
- Low power consumption (4mA @ 1 MHz) allows battery-powered operation
- Enhanced instruction set: 27 additional op codes encompassing eight new instructions enhance software performance compared to existing NMOS 6500 microprocessor instruction set
 - -64 microprocessors instuctions
 - —178 operational codes
- —15 addressing modes
- · 65K-byte addressable memory
- 1, 2, 3, 4, 5 or 6 MHz operation
- · Choice of external or on-board clock generator operation
- On-board clock generator/oscillator can be driven by an external single-phase clock input, an RC network, or a crystal circuit
- Advanced memory access timing (ϕ 4) on selected versions
- Early address valid allows use with slower memories
- · Early write data for dynamic memories
- 8-bit parallel processing
- · Decimal and binary arithmetic
- Pipeline architecture
- Programmable stack pointer
- · Variable length stack
- Interrupt capability
- Non-maskable interrupt
- 8-bit bidirectional data bus
- "Ready" input (for single cycle execution)
- · Direct memory access capability
- Bus compatible with M6800
- Available on selected versions, a memory lock output and bus enable input signals simplify multiprocessor designs

General Description

The G65SCXXX 8-bit microprocessor family is manufactured using the state-of-the-art silicon gate CMOS process. The G65SC02 and G65SC12 devices are pin-to-pin compatible with NMOS versions of the 6500 currently on the market. The G65SC102 and G65SC112 devices include several enhancements not available with other designs. All of the microprocessors are software compatible and provide 65K bytes of memory addressing and two interrupt inputs. All are bus compatible with MC6800 products.

As shown in Table I, the G65SC02, G65SC102 and G65SC112 clock generator circuit may be driven by an external crystal (Figure 2a), an RC network (Figure 2b) or by an external clock source. The G65SC12 requires an external clock source and is intended for multiprocessor applications where maximum timing control is necessary. The three family members with on-chip oscillators are intended for high performance, low cost operations where single phase inputs, crystals, or RC inputs provide the time base.

All of the microprocessors in the G65SCXXX family are pin-to-pin compatible with the NMOS 6500 microprocessors offered by several other manufacturers. However, the use of the leading-edge CMOS process technology ensures several software or programming enhancements not available to users fo the NMOS 6500. The enhancements include two additional addressing modes, an expanded microprocessor instruction set (from 56 to 64 instructions), and expanded operational codes (from 151 to 178). In addition, a series of operational enhancements are provided which materially improve the effective use of the microprocessor. These enhancements are explained in Table V of the section of this data sheet devoted to system software and programming. This series of microcessors provides the user an architecture and instruction set with which he is basically familiar (6502), the several operational enhancements notwithstanding, plus all of the advantages of leading edge CMOS technology; i.e., increased noise immunity, higher reliability, and greatly reduced power consumption.

Table I. G65SCXXX Family Microprocessor Capabilities

ITEM NO.	PART NUMBER	DIP PINS	ADDRESSABLE MEMORY (BYTES)	ON-BOARD CLOCK OSCILLATOR (SEE NOTE)	EXTERNAL CLOCK GENERATOR REQUIRED	ADVANCED MEMORY ACCESS (\$\phi4)	ĪRQ	NMI	so	DBE	BE	SYNC	RDY	ML	RES
1	G65SC02	40	65K	•			•	•	•			•	•		•
2	G65SC12	40	65K		•		•	•	•	•		•			•
3	G65SC102	40	65K	•		•	•	•	•		•	•	•	•	
4	G65SC112	40	65K	•			•	•	•		•	•	•	•	•

NOTE: These devices can operate in any of the following clock generation modes

1 External crystal

2 External RC network

3 dO(IN) from external clock source



General Description (Continued)

In addition to enhanced software programming, the use of CMOS processing also allows several hardware enhancements that are not available to users of the NMOS 6500 products. These hardware enhancements are listed and explained in Table II.

The G65SC102 offers the advantage of an on-board divide-by-four oscil-

lator, increasing the available access time (tACC) by approximately 25%. All versions of the G65SCXXX microprocessor family are available in plastic, ceramic, cerdip, or leadless chip carrier packaging. All versions are available in 1, 2, 3, 4, 5 and 6 MHz maximum operating frequencies.

Absolute Maximum Ratings: (Note 1)

Rating	Symbol	Value	Unit
Supply Voltage	Voo	-0.3 to +7.0	٧
Input Voltage	VIN	-0.3 to Vpp +0.3	٧
Operating Temperature	TA	-40 to +85	°C
Storage Temperature	Ts	-55 to +150	°C

This device contains input protection against damage due to high static voltages or electric fields; however, precautions should be taken to avoid application of voltages higher than the maximum rating.

Notes:

 Exceeding these ratings may result in permanent damage. Functional operation under these conditions is not implied.

DC Characteristics: $VDD = 5.0V \pm 5\%$, VSS = 0V, TA = -40°C to +85°C Industrial, 0° to +70°C Commercial

Parameter	Symbol	Min	Max	Unit
Input High Voltage \$\delta 0(IN), CLK (IN) \$\delta 2 (IN) \$\overline{RES}, \overline{NMI}, \overline{RDY}, \overline{IRQ}, \overline{Data}, \overline{SO}, \overline{DBE}, \overline{BE}	ViH	2.4 V _{DD} – 0.2 2.0	Vob + 0.3 Vob + 0.3 Vob + 0.3	V V
Input Low voltage ### ### ### ### ### ### ### ### ### #	VIL	- 0.3 - 0.3 - 0.3	0.4 0.2 0.8	V V V
Input Leakage Current (Vin = 0 to Vop) RES, NMI, RDY, IRQ, SO, DBE, BE (Internal Pull-Up). CLK (IN) [102] \$\psi_2\$ (IN), \$\phi_0\$ (IN), CLK (IN) [02, 12, 112]	NII		1.0/-100 ±1.0	μ Α μ Α
Three-State Leakage Current Address, Data, R/W	ITSI		± 10.0	μΑ
Output High Voltage (IOH = $-100~\mu\text{A}$, Vob = 4.75V) SYNC, Data, A0–A15, R/W	Voн	2.4		v
Output Low Voltage (IoL = 1.6 mA, VDD = 4.5V) SYNC, Data, A0A15, R/W	Vol	_	0.4	V
Supply Current f = 1 MHz (No Load) f = 2 MHz f = 3 MHz f = 4 MHz	aal	_	4 8 12 16	mA
Standby Power Dissipation ($\phi 2 = V_{iH}$, Inputs = Vss or VDD Outputs Unloaded)	Psay		50.0	μW
Capacitance (Vin = 0, Ta = 25°C, f = 1 MHz Logic, ϕ 0(IN), CLK (IN) A0-A15, R/W Data (Three-State) ϕ 2 (IN)	Cin Cts C2(IN)	_ _ _ _	10 15 40	pF



AC Characteristics, G65SC02, G65SC12, G65SC112: $V_{DD} = 5.0V \pm 5\%$. TA = -40° C to $+85^{\circ}$ Industrial. 0° C to $+70^{\circ}$ C Commercial

		1 N	ИНz	2 1	ЛНZ	3 N	ИНZ	4 M	ИНZ	5 N	ЛНz	6 N	ИHz	
Parameter	Symbol	Min	Max	Min	Мах	Min	Max	Min	Max	Min	Max	Min	Max	Unit
Delay Time, φ0 (IN) to φ2 (OUT)	to <i>ф</i> 0		40		40	1	40	-	40		35		30	nS
Delay Time, $\phi 2$ (IN) to $\phi 2$ (OUT)	tD φ 2		35		35	_	35		35	_	35	_	30	nS
Detay Time, φ1 (OUT) to φ2 (OUT)	tD φ 1		50	_	50	-	50		50	_	35	_	30	NS
Delay Time, φ2 (OUT) to OSC (OUT)	toosc	_	50	_	50		50	_	50	_	35		30	nS
Cycle Time	toyo	1.0	DC	0.50	DC	0.33	DC	0.25	DC	0.20	DC	0.167	DC	μS
Clock Pulse Width Low	tpw (ø2L)	430	10000	210	10000	150	10000	100	10000	90	10000	80	10000	nS
Clock Pulse Width High	tρw (φ2H)	450	_	220	_	160	_	110	1	85	_	75	_	nS
Fall Time, Rise Time	tr, ta	_	25	-	20	_	15	_	12	_	10		10	nS
Address Hold Time	tan	15	_	15		15	_	15	_	5		5		nS
Address Setup Time	tads	_	125	_	100	_	85	1	70	_	60	_	55	nS
Access Time	tacc	775		340	_	200	_	140	-	110		85		nS
Read Data Hold Time	t DHR	10	_	10	_	10	_	10	-	5	_	5		nS
Read Data Setup Time	tosa	100		60	_	40	_	30	-	27	_	25	_	nS
Write Data Delay Time	twos	_	175	_	100	_	75		55	_	50	_	45	nS
Write Data Hold Time	tonw	30	-	30	_	30	_	30	_	15	_	15		nS
SYNC, ML Setup Time	tsy, tml	_	125	_	100	_	85		70	_	60	_	55	nS
SYNC, ML Hold Time	tsyn, TMLH	10	_	10		10	_	10		5		5	_	пS
SO Setup Time	tso	75		50		35	_	25		22	_	20	_	nS
Processor Control Setup Time	tPSC	200		110		80	_	60		55	_	50		nS

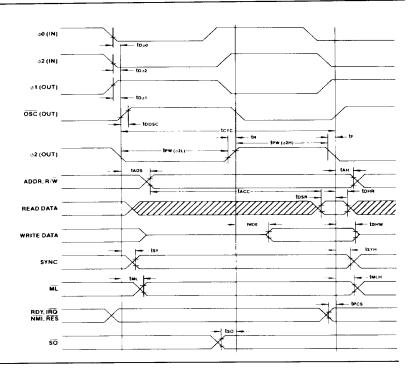
AC Characteristics, G65SC102: $V_{DD} = 5.0V \pm 5\%$. TA = -40° C to $\pm 85^{\circ}$ C Industrial, 0° C to $\pm 70^{\circ}$ C Commercial

		1 N	ИHz	21	ИHz	3 1	ИНz	4 8	ИНZ	5 N	ИHz	61	ИHz	
Parameter	Symbol	Min	Max	Min	Max	Min	Мах	Min	Max	Min	Max	Min	Max	Uni
Delay Time, CLK (IN) to φ2 (OUT)	tclk	_	75	_	75	_	75	_	75	_	60	_	50	nS
Delay Time, \overrightarrow{OSC} (OUT) to $\phi2$ (OUT)	toosc	_	70		70		70		70		55	_	45	n
Cycle Time	tcyc	1.0	DC	0.50	DC	0.33	DC	0.25	DC	0.20	DC	0.167	DC	μS
Clock Pulse Width Low	tρw (φ2L)	430	10000	210	10000	150	10000	100	10000	90	10000	80	10000	пS
Clock Pulse Width High	tρw (φ2H)	450		220	-	160	_	110	_	85	_	75	_	nS
Fall Time, Rise Time	tF, tA	_	25	_	20	_	15	_	12	_	10	_	10	nS
Delay Time, $\phi2$ (OUT) to $\phi4$ (OUT)	tavs	_	250	_	125	_	83	_	63	_	52	_	42	nS
Address Valid to ϕ 4 (OUT)	ta <i>ф</i> ₄	100	_	25	_	16	_	12	_	8	_	5	_	пS
Address Hold Time	tan	15	_	15	_	15	_	15	-	10	_	10	_	nS
Access Time	tacc	775	_	340		200	_	140	_	110	_	85	_	nS
Read Data Hold Time	tohr	10	_	10	_ :	10	_	10	_	5	_	5	_	nS
Read Data Setup Time	tosa	100	_	60	_	40	_	30	_	27	_	25	_	nS
Write Data Hold Time	tonw	30	_	30	_	30		30	_	15	_	15	_	nS
Write Data Delay Time	tDD <i>ф</i> 4	_	200	-	110	_	85		65		50		45	nS
SYNC, ML Setup Time	tsy, tml	_	125	_	100	_	85	-	70	_	60		55	nS
SYNC, ML Hold Time	tsyn, tmlh	10	_	10	_	10	_	10	_	5	_	5	_	nS
SO Setup Time	tso	75	-	50	_	35	_	25	_	22	_	20	_	nS
Processor Control Setup Time	tPCS	200	_	110	_	80	Г —	80	_	55	_	50	_	nS



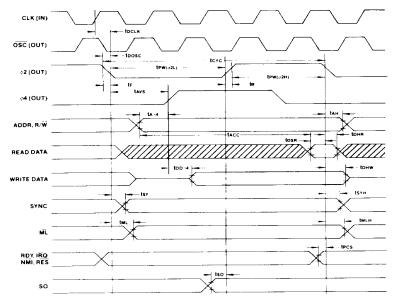
TIMING DIAGRAM:

G65SC02 G65SC12 G65SC112



TIMING DIAGRAM:

G65SC102

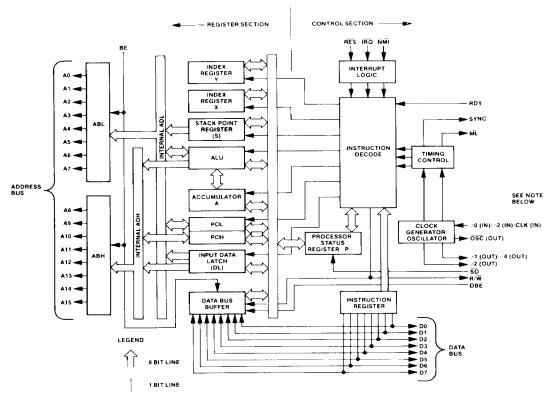


Notes 1 Load = 100 pF.

Voltage levels shown are VL = 0.4 V, VH = 2.4 V, unless otherwise specified.

3. Measurement points shown are 0.8 V and 2.0 V, unless otherwise specified.





Note: Refer to Table I for signal input/output applicability.

Figure 1. Internal Architecture Simplified Block Diagram

Functional Description

Timing Control

The timing control unit keeps track of the instruction cycle being monitored. The unit is set to zero each time an instruction fetch is executed and is advanced at the beginning of each phase one clock pulse for as many cycles as is required to complete the instruction. Each data transfer which takes place between the registers depends upon decoding the contents of both the instruction register and the timing control unit.

Program Counter

The 16-bit program counter provides the addresses which step the microprocessor through sequential instructions in a program.

Each time the microprocessor fetches an instruction from program memory, the lower byte of the program counter (PCL) is placed on the low-order bits of the address bus and the higher byte of the program counter (PCH) is placed on the high-order 8 bits. The counter is incremented each time an instruction or data is fetched from program memory.

Instruction Register and Decode

Instructions fetched from memory are gated onto the internal data bus. These instructions are latched into the instruction register then decoded, along with timing and interrupt signals, to generate control signals for the various registers.

Arithmetic and Logic Unit (ALU)

All arithmetic and logic operations take place in the ALU including incrementing and decrementing internal registers (except the program counter). The ALU has no internal memory and is used only to perform logical and transient numerical operations.

Accumulator

The accumulator is a general purpose 8-bit register that stores the results of most arithmetic and logic operations. In addition, the accumulator usually contains one of the two data words used in these operations.



Functional Description (Continued)

Index Registers

There are two 8-bit index registers (X and Y), which may be used to count program steps or to provide an index value to be used in generating an effective address

When executing an instruction which specifies indexed addressing, the CPU fetches the op code and the base address, and modifies the address by adding the index register to it prior to performing the desired operation. Pre- or post-indexing of indirect addresses is possible.

Stack Pointer

The stack pointer is an 8-bit register used to control the addressing of the variable-length stack. The stack pointer is automatically incremented and

decremented under control of the microprocessor to perform stack manipulations under direction of either the program or interrupts ($\overline{\text{NM}}$ and $\overline{\text{IRQ}}$). The stack allows simple implementation of nested subroutines and multiple level interrupts

Processor Status Register

The 8-bit processor status register contains seven status flags. Some of the flags are controlled by the program, others may be controlled both by the program and the CPU. The 6500 instruction set contains a number of conditional branch instructions which are designed to allow testing of these flags.

Signal Description

Address Bus (AO-AXX)

Refer to the particular package configuration for the respective number of address lines.

In both the 40-pin and 44-pin packages, A0-A15 forms a 16-bit address bus for memory and I/O exchanges on the data bus. The address lines are set (See BE below.) to the high impedance state by the bus enable (BE) signal. The output of each address line is TTL compatible, capable of driving one standard TTL load and 130 pF.

Bus Enable (BE)

This signal allows external control of the data and the address output buffers and R/ $\overline{\mathbb{W}}$. For normal operation, BE is high causing the address buffers and R/ $\overline{\mathbb{W}}$ to be active and the data buffers to be active during a write cycle. For external control, BE is held low to disable the buffers.

Clock in (CLK (IN))

The 65SC10X Series is supplied with an internal clock generator operating at four times the $\phi 2$ frequency. The frequency of these clocks is externally controlled by the crystal or oscillator circuit shown in Figure 2.

Phase 0 in $(\phi 0(IN))$

This is the buffered clock input to the internal clock generator on the G65SCOX series. Clock outputs $\phi1(OUT)$ and $\phi2(OUT)$ are derived from this signal.

Phase 2 In (φ2(IN))

This is the unbuffered clock input to the internal clock generator on the G65SC1X and G65SC11X series. The clock output, ϕ 2(OUT), is derived from this signal

Data Bus Enable (DBE)

This TTL-compatible input allows external control of the three-state data output buffers. In normal operation, DBE would be driven by the phase two (\d2) clock, thus allowing data input from microprocessor only during \d2. During the read cycle, the data bus buffers are internally disabled, becoming essentially an open circuit. To disable the data bus externally, DBE should be held low.

Data Bus (D0-D7)

The data lines (D0-D7) constitute an 8-bit bidirectional data bus used for data exchanges to and from the device and peripherals. The outputs are three-state buffers capable of driving one TTL load and 130 pF. The data lines are set to the high impedance state by BE or DBE.

Interrupt Request (IRQ)

This TTL compatible signal requests that an interrupt sequence begin within the microprocessor. The \overline{IRQ} is sampled during $\phi 2$ operation; if

the interrupt flag in the processor status register is zero, the current instruction is completed and the interrupt sequence begins during \$1. The program counter and processor status register are stored in the stack. The microprocessor will then set the interrupt mask flag high so that no further interrupts may occur. At the end of this cycle, the program counter low will be loaded from address FFFE, and program counter high from location FFFF, transferring program control to the memory vector located at these addresses. The RDY signal must be in the high state for any interrupt to be recognized. A 3K ohm external resistor should be used for proper wire-OR operation.

Memory Lock (ML)

In a multiprocessor system, $\overline{\text{ML}}$ indicates the need to defer the rearbitration of the next bus cycle to ensure the integrity of read-modify-write instructions $\overline{\text{ML}}$ goes low during ASL, DEC, INC, LSR, ROL, ROR, TRB, TSB memory referencing instructions. This signal is low for the modify and write cycles.

Non-Maskable Interrupt (NMI)

A negative-going edge on this input requests that a non-maskable interrupt sequence be generated within the microprocessor. The NMI is sampled during \$\phi_2\$: the current instruction is completed and the interrupt sequence begins during \$\phi_1\$. The program counter is loaded with the interrupt vector from locations FFFA (low byte) and FFFB (high byte), thereby transferring program control to the non-maskable interrupt routine. However, it should be noted this is an edge-sensitive input. As a result, another interrupt will occur if there is a nother negative-going transition and the program has not returned from a previous interrupt. Also, no interrupt will occur if NMI is low and negative-going edge has not occurred since the last non-maskable interrupt.

Oscillator Out (OSC (OUT))

On the G65SC102 microprocessor, an internal inverter and a resistor are connected between pins 35 and 37 on the DIP package and pins 39 and 41 on the PLCC package. The inverter has sufficient loop gain to provide oscillation using an external crystal.

Phase 1 Out (ϕ 1(OUT))

This inverted $\phi 2(OUT)$ signal provides timing for external R/ \overline{W} operations.

Phase 2 Out (\$\phi 2(OUT))

This signal provides timing for external bus R/ \overline{W} operations. Addresses are valid after the address setup time (tADS) from the falling edge of ϕ 2(OUT).

This signal is delayed by tavs from ϕ 2(OUT). The address output is valid prior to the rising ϕ 3e of ϕ 4(OUT).



Signal Description (Continued)

Ready (RDY)

This input signal allows the user to single-cycle the microprocessor on all cycles including write cycles. A negative transition to the low state during or coincident with phase one (#1) will halt the microprocessor with the output address lines reflecting the current address being fetched. This condition will remain through a subsequent phase two (#2) in which the ready signal is low. This feature allows microprocessor interfacing with low-speed memory as well as direct memory access (DMA).

Reset (RES)

This input is used to reset the microprocessor. Reset must be held low for at least two clock cycles after VDD reaches operating voltage from a power down. A positive transition on this pin will then cause an initialization sequence to begin. After the system has been operating, a low on this line of at least two cycles will cease microprocessing activity.

When a positive edge is detected, there is an initialization sequence tasting six clock cycles. The previous program counter and status register values are written to the stack memory area. Then the interrupt mask flag is set, the decimal mode is cleared and the program counter is loaded with the restart vector from locations FFFC (low byte) and FFFD (high byte). This is the start location for program control. This input should be high in normal operation.

Read/Write (R/W)

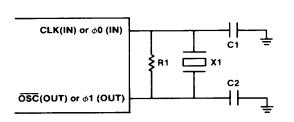
This signal is normally in the high state indicating that the microprocessor is reading data from memory or I/O bus. In the low state the data bus has valid data from the microprocessor to be stored at the addressed memory location. R/\overline{W} is set to the high impedance state by BE.

Set Overflow (SO)

A negative transition on this line sets the overflow bit in the status code register. The signal is sampled on the trailing edge of ϕ 1.

Synchronize (SYNC)

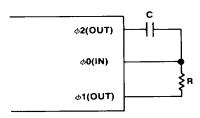
This output line is provided to identify those cycles during which the microprocessor is doing an OP CODE fetch. The SYNC line goes high during ϕ 1 of an OP CODE fetch and stays high for the remainder of that cycle. If the RDY line is pulled low during the ϕ 1 clock pulse in which SYNC went high, the processor will stop in its current state and will remain in the state until the RDY line goes high. In this manner, the SYNC signal can be used to control RDY to cause single instruction execution



C1, C2 = 51pF R1 = 200K Ω (not required for G65SC102)

X1 = 1MHz

Figure 2(a). Crystal Circuit for internal Oscillator



Suggested RC network configuration for internal oscillator.

1 MHz operation at VDD = 5.0V; C = 56pF

R = 5.6 KΩ

Figure 2(b). RC Circuit for Internal Oscillator

Table II. Microprocessor Hardware Enhancements

Function	NMOS 6500	G65SCXXX Family
Oscillator.	Requires external active components.	Crystal or RC network will oscillate when connected between $\phi 0$ (IN) and $\phi 1$ (OUT).
Assertion of Ready (RDY) during write operations.	Ignored.	Stops processor during $\phi2$
1X series clock inputs.	Two non-overlapping clock inputs (ϕ 1 and ϕ 2) are required.	φ2 (IN) is the only required clock.
Unused input-only pins (IRQ, NMI, RDY, RES, SO, DBE, BE).	Must be connected to low impedance signal to avoid noise problems.	Connected internally by a high-resistance to Voo (approximately 1 Megohm).



Addressing Modes

Fifteen addressing modes are available to the user of the GTE G65SCXXX family of microprocessors. The addressing modes are described in the following paragraphs:

Implied Addressing

In the implied addressing mode, the address containing the operand is implicitly stated in the operation code of the instruction.

Accumulator Addressing

This form of addressing is represented with a one byte instruction and implies an operation on the accumulator.

Immediate Addressing

With immediate addressing, the operand is contained in the second byte of the instruction; no further memory addressing is required.

Absolute Addressing

For absolute addressing, the second byte of the instruction specifies the eight low order bits of the effective address while the third byte specifies the eight high order bits. Therefore, this addressing mode allows access to the total 65K bytes of addressable memory.

Zero Page Addressing

Zero page addressing allows shorter code and execution times by only fetching the second byte of the instruction and assuming a zero high address byte. The careful use of zero page addressing can result in significant increase in code efficiency.

Absolute Indexed Addressing

Absolute indexed addressing is used in conjunction with X and Y index register and is referred to as "Absolute, X," and "Absolute, Y." The effective address is formed by adding the contents of X and Y to the address contained in the second and third bytes of the instruction. This mode allows the index register to contain the index or count value and the instruction to contain the base address. This type of indexing allows any location referencing and the index to modify multiple fields resulting in reduced coding and execution time.

Zero Page Indexed Addressing

Zero page absolute addressing is used in conjunction with the index register and is referred to as "Zero Page, X" or "Zero Page, Y." The effective address is calculated by adding the second byte to the contents of the index register. Since this is a form of "Zero Page" addressing, the content of the second byte references a location in page zero. Additionally, due to the "Zero Page" addressing nature of this mode, no carry is added to the high order eight bits of memory and crossing of page boundaries does not occur.

Relative Addressing

Relative addressing is used only with branch instruction; it establishes a destination for the conditional branch.

Zero Page Indexed Indirect Addressing

With zero page indexed indirect addressing (usually referred to as Indirect X) the second byte of the instruction is added to the contents of the X index register, the carry is discarded. The result of this addition points to a memory location on page zero whose contents is the low order eight bits of the effective address. The next memory location in page zero contains the high order eight bits of the effective address. Both memory locations specifying the high and low order bytes of the effective address must be in page zero.

Absolute Indexed Indirect Addressing (Jump Instruction Only)

With absolute indexed indirect addressing, the contents of the second and third instruction bytes are added to the X register. The result of this addition points to a memory location containing the lower-order eight bits of the effective address. The next memory location contains the higher-order eight bits of the effective address.

Indirect Indexed Addressing

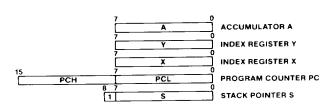
This form of addressing is usually referred to as Indirect, Y. The second byte of the instruction points to a memory location in page zero. The contents of this memory location is added to the contents of the Y index register, the result being the low order eight bits of the effective address. The carry from this addition is added to the contents of the next page zero memory location, the result being the high order eight bits of the effective address.

Zero Page Indirect Addressing

In this form of addressing, the second byte of the instruction contains the low order eight bits of a memory location. The high order eight bits is always zero. The contents of the fully specified memory location is the low order byte of the effective address. The next memory location contains the high order byte of the effective address.

Absolute Indirect Addressing (Jump Instruction Only)

The second byte of the instruction contains the low order eight bits of a memory location. The high order eight bits of that memory location is contained in the third byte of the instruction. The contents of the fully specified memory location is the low order byte of the effective address. The next memory location contains the high order byte of the effective address which is loaded into the 16 bits of the program counter.



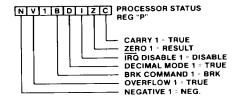


Figure 3. Microprocessor Programming Model



Table III. Instruction Set—Alphabetical Sequence

Add Memory to Accumulator with Carry "AND" Memory with Accumulator ANO NOP Shift One Bit Left Branch on Carry Clear Branch on Carry Set Branch on Result Zero ASL BCC ORA PHA BCS BEQ PHX PHY Test Memory Bits with Accumulator Branch on Result Minus BIT PLA PLP Branch on Result Not Zero BNE Branch on Result Plus Branch Always PLX PLY BRA Branch Always
Force Break
Branch on Overflow Clear
Branch on Overflow Set
Clear Carry Flag BRK BOL ROR RTI CLC Clear Decimal Mode Clear Interrupt Disable Bit Clear Overflow Flag RTS SBC CLD CLI SEC SED CMP CPX Compare Memory and Accumulator Compare Memory and Index X SEI STA Compare Memory and Index X Compare Memory and Index Y Decrement by One Decrement Index X by One Decrement Index Y by One CPY DEC STX DEX STZ
 TAX DEY "Exclusive-or" Memory with Accumulator Increment by One EOR TAY Increment Index X by One Increment Index Y by One INX TSB KST JMP Jump to New Location JSR LDA Jump to New Location Saving Return Address
Load Accumulator with Memory LDX Load Index X with Memory

New Instruction

LOY Load Index Y with Memory
LSR Shift One Bit Right
NOP
No Operation
ORA "OR" Memory with Accumulator
PHA
Push Accumulator on Stack
PHY
Push Processor Status on Stack
PHY
Push Index Y on Stack
PHY
Push Index Y on Stack
PLA
Pull Accumulator from Stack
PLP
PUS
PLA
PUB Index W from Stack
PLY
PUI Index Y from Stack
PLY
PUI Index Y from Stack
PUI Index Y from Accumulator with Borrow
SEC
PUI Index Y from Accumulator with Borrow
SEC
Set Carry Flag
SED
SET Decimal Mode
SEI
SET Interrupt Disable Bit
STA Store Accumulator in Memory
STY
Store Index X in Memory
STY
Transfer Accumulator to Index X
Transfer Accumulator to Index X
Transfer Index X to Accumulator
TSB
TSB Tast and Set Memory Bits with Accumulator
TSB
TSB Tast and Set Memory Bits with Accumulator
TSB
TSB Tast From Stack
TANA Transfer Index X TA Accumulator

TSX Transfer Stack Pointer to Index X TXA Transfer Index X to Accumulator TXS Transfer Index X to Stack Pointer TYA Transfer Index Y to Accumulator

LSD															\ \ \		[
MSD	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Ε	F	
0	BRK	ORA			798	ORA	ASL		PHP	ORA	ASL		158	ORA	ASL	- 1	0
		ind, X	i i		100	zpg	zpg			imm	Α		303	abs	abs		
1	BPL	ORA	ORA		TAB	ORA	ASL		CLC	ORA	INC			ORA	ASL		1
	rel	ind, Y	und:		100	zpg. X	zpg, X			abs, Y	A			abs, X	abs, X		
2	JSR	AND			BIT	AND	ROL		PLP	AND	ROL		віт	AND	ROL		2
	abs	ind, X			zpg	zpg	zpg			imm	Α		abs	abs	abs		
3	вмі	AND	AND		- 817	AND	ROL		SEC	AND	OLL		2	AND	ROL		3
	rel	ind, Y	i inai '		zpg. X	zpg, X	zpg, X			abs, Y	A		alle X	abs, X	abs, X		
4	RTI	EOR				EOR	LSR		PHA	EOR	LSR		JMP	EOR	LSR		4
		ind, X				zpg	zpg			imm	Α		abs	abs	abs		
5	BVC	EOR	EOR			EOR	LSR		CLI	EOR	Print.			EOR	LSR		5
	rel	ind, Y	ind.			zpg. X	zpg. X			abs, Y				abs, X	abs, X		
6	RTS	ADC		·	\$1Z	ADC	ROR		PLA	ADC	ROR		JMP	ADC	ROR		6
		ind, X			709	zpg	zpg			imm	Α		ind	abs	abs		
7	BVS	ADC	ADC		stz	ADC	ROR		SEI	ADC	PLY		DMP	ADC	ROR		7
	rel	ind, Y	ind		zpg, X	zpg. X	zpg. X			abs. Y		L	ing X	abs, X	abs, X		
8	BRA	STA			STY	STA	STX		DEY	BIT	TXA		STY	STA	STX		8
	ret	ind, X			zpg	zpg	zpg			i mmit			abs	abs	abs		
9	всс	STA	ATE		STY	STA	STX		TYA	STA	TXS		STZ	STA	377		9
	rel	ınd, Y	ind		zpg. X	zpg. X	zpg, Y			abs, Y			atas	abs, X	W/k		
Α	LDY	LDA	LDX		LDY	LDA	LDX		TAY	LDA	TAX		LDY	LÐA	LDX		Α
	ımm	ınd, X	ımm		zpg	zpg	zpg			imm			abs	abs	abs		
В	BCS	LDA	LDA		LDY	LDA	LDX		CLV	LDA	TSX		LDY	LDA	LDX		В
1 1	rel	ınd, Y	ind		zpg. X	zpg. X	zpg. Y			abs. Y			abs, X	abs, X	abs. Y		
С	CPY	CMP			CPY	CMP	DEC		INY	CMP	DEX		CPY	CMP	DEC		С
1 1	ımm	ind, X			zpg	zpg	zpg			ımm			abs	abs	abs		
D	BNE	СМР	GMP			СМР	DEC		CLD	CMP	PHX			CMP	DEC		D
	rel	⊧nd, Y	ind			zpg. X	zpg. X			abs, Y				abs. X	abs, X		
E	CPX	SBC			CPX	SBC	INC		INX	SBC	NOP		CPX	SBC	INC		E
	ımm	ind, X	L		zpg	zpg	zpg			ımm	NAME BOOKER (AND ADDRESS)		abs	abs	abs		
F	BEQ	SBC	SBC			SBC	INC		SED	SBC	, PLX			SBC	INC		F
	rel	ind. Y	ind			zpg. X	zpg. X			abs. Y			ļ	abs, X	abs. X		<u> </u>
	0	1	2	3	4	5	6	7	8	9	A	В	С	D	E	F	<u> </u>

Note - New Op Codes

Figure 4. Microprocessor Op Code Table



Table IV. Operational Codes, Execution Time, and Memory Requirements

			_	-					_	_			_	_			-	_			_	_		_	Ť		_	$\overline{}$	IND		$\overline{}$			_			ESS	OB	1		
	!		IME-		ABS			ERO AGE		(4) MPL II		(IND	ع, x	a le	(1) (IND)		1 2	ZPG.	إي		1) 3S.X	×		(1) 3S,Y		HEL	LA- E (2)		REC		1 7	ZP(G,Y	ST					_		
MNE-		1-5	骭	+	+	쒸	٢	ÜΈ	+	1	Ħ		Ť	+	T	T	Γ	Ť	\Box	Ť	Ť	+	Ť	Ť	1	T	Ť	+	Ť	Т	Т	T	Т	7	6 4	4 3	3 2	1 0	N	MNE-	٦
MONIC	OPERATION		n #	_	-	n #	OР	-	_)P n	. #	ОР	-		OP r	<u>n #</u>]	OF				_	-	_	n #	\rightarrow	OP I	n#	_				Pr	<u> 1</u> #					ZC		ONIC	4
ADC	A + M + C - A (3)		2 2			4 3									71 5			5 4		7D 3D				4 3		- 1			72 5 32 5	5 2		1						z c z •		ADC	1
AND	A^M - A C - [7 0] - 0	29	2 2		2D 4	4 3 6 3		3 2		na z	, , ,	21	6 2	1	31 5	3 4				1E			35	آ"،	,		,	~	1	1				N.			• •	z c		ASL	
ASL BCC	BRANCH IF C-0	1 '	11	~	"[3 "	1	1	1	γ	11	, 1	()	1			1	1	1	ιŢ	۱,	Ĭ	-	.			2 2													BCC	
BCS	BRANCH IF C-1	<u>'</u>	Ц	\perp	\perp	'ـــــــــــــــــــــــــــــــــــــ	ا_ــــــــــــــــــــــــــــــــــــ	4	\perp	4	Ш	لــا	4	\perp	4	⊥'	\perp	1	₽	\sqcup	4	4	_	+			2 2		+	+	+	+	+	÷٠	• '		• •	••		BCS	\dashv
BEQ	BRANCH IF Z-1	T '	П	T	7	Τ.'	ſ., '	$\tilde{\Box}$		1	1	Ü	11		- 1		1.				c.l	.	-)	4	.	FO	2 2	4	1								• •			BEO	
BIT	A A M (5)	891	2 7	2 2	2C 4	4 3	24	3 2	2			1			1	- '	34	4 4	2	зс	(4)	3	-)	(L	.	30	2 2	,						^	•			• •		BMI	
8MI SNE	BRANCH IF N 1	1 '	$ \cdot $		- ['	'	1			11	(-)			-	1	1		17	H	1			(L			2 2		-				-	1.		• •			۱ ا	BNE	
BNE BPL	BRANCH IF Z:0 BRANCH IF N:0	'	11	١	- 1	- '	'	11		-	11	(-)	\Box		1		\	L	U	Ш	Ш	1		Ш	\perp	10	2 2	2	1	\perp	\perp	1	\perp	Ŀ	•	• •	• •	• •		BPL	
BRA	BRANCH ALWAYS	+-	H	+	\uparrow	+	\vdash	\prod	+	\top	+	\Box	T	+	\top	T		\top	7	\Box	\Box	\Box		П			2 2		T	T	T	٦	7	•	•	-		• •		BRA	
BRK	BREAK	1		1	- 1	1	'	11	- 14	00 7	7 1)	1		1					1			i	. 1	ιŢ	.]	50	<u>ال</u> ا.		-			1	1		•	1 (J 1	• •		BRK	
BVC	BRANCH IF V-0	'	11				'	11			10	[]					Į		'	$\left(-\right)$		(. !	()	.		2 2			Į				1:	:	•		: .		BVS	1
BVS	BRANCH IF V-1	'	11		- 1				1	18 2	1,1	1	1			-			'		()	i L	, !	11	. [(6)	["						.	.		•		• 0		CLC	
CLC	0 - C 0 - D	1				.	'	11		18 2 D8 2				- 1	1				1.		\mathbf{I}	\Box	1		1	!	\prod	L	1	1	L	1	1	Ŀ			0 •			CLD	
CLD	0 -1	+-	H	+	\forall	+	十	1		58 2			\Box	\top	\top	T	\vdash	1			\Box	П	,	П	Т		П	T	7	T	T	_[1	•	•	•	• 0			CLI	-
CLV	0 · V			.		.		11	6	B8 2		1 !			- 1	1.			1.		\Box	i,		1.1		. !		١,				1		:	0	•	• •	• •		CLV	
CMP	A-M							5 3 2			17	C1	6	2	D١	5 2	. D	15 4	1 2	DD	[4]	3	D9	141	3	. 1		L	02 5	5 2	2		. [N N				ZC		CMP	
CPX	X-M	E0	2	2 F	EC]	4 3	E4	4 3 2	2		17	'		. ['	[]	$(\)$	(, !	\mathbf{I}		. 1						- [.	2 2				2 C		CPY	
CPY	Y-M	Cu	121					4 3 2 6 5 2		3A 2	#	+	+	+	+	+	+	76 F	4/2	DE	16	13	$\overline{}$	+	仕		+	十	+	+	+	\top	\top					Z •		DEC	╗
DEC	DEGREMENT X-1 - X		11	. `	اعد	ا ا	0	13.		CA 2			\perp			.	-	1	T	107	11	ĭ	i '		e I	, 1	11	1	-		1		. [N			• •	z •		DEX	
DEX	X-1 - X Y-1 Y		11	.		<i>i</i>			١,	88 2		1	11	.	- 1					'			i '	11						.			, 1					Z •		DEY	-
EOR	A V M -A	49	3 2					5 3 2	2		- '		6	2	51	5 2				5D			59	4	3	. !	11	15	52 5	5 2	2		<i>i</i>					Z •		EOR	- 1
INC	INCREMENT	\perp	Ш	4	EΕ	6 3	E6	6 5 2		1A 2			4	4		+	<u> </u>	6 6	2 إذ	FE	161	13		₩	\dashv		+	+	+	+	+	+	+	_				Z •	-	INX	\dashv
INX	X + 1 · X	1] [1	- 1	i L		11		E8 2			11	.						'	$\{ \}$		t	11	(, '	1			.		- }		2 2				Z •		INX	
INY	Y+1 ·Y	. [\Box		ار.	3 3		11	. T	C8 2	2	70	6	12	- 1	.				1	17	11	l	11	1	i '	11	1	6C	6	3	- }	cΤ			•		· • •		JMP	
JMP	JUMP TO NEW LOC		\Box			6 3			i L	Ì	1	ļ	11	П	- 1	.				1 '	11	11	1	1	(J	i '	П		Ì			1	i [•			٠	JSR	
JSR LDA	M · A	AF	9 2					5 3 :	12	1	1	A1	6	12	В1	15 2	2 L F	35 4	4 2	BD	14					<u>'</u>	Ц	4	B2 :	5 :			Ц					Z •	-	LDA	_
LDX	M · X	A2	2 2	2 /	ΑE	4 3	A6	6 3	2	\neg	\top		\Box	T	\neg	T.	T		Т		П	П	BE	4		Ē	Γ				ों।	В6	4				• •			LDX	
LDY	M·Y			2 4	AC	4 3	3 A4	4 3 :	2					(L	J	(BC])	()	1				ıΙ		-)	(. z •		LDY	
LSR	0 · 7 0 - C		11	1	4E	6 3	. 46	6 5			2 1		11	1	J	i [1 5	56 e	3 2	5E	(6)	3	1	1	(-)	ĺ	11	. 1	1			- 1	1	:	:					NOP	
NOP	NO OPERATION	1 ~	اړا	12	20	10	.	5 3		EA	2 1		1 6	ادا	11	5 2	2	15 4	4 2	, , , ,	1/4	31	19	4 4	13	í	\prod	.	12	(5	2	- 1	$\left(\cdot \right)$	N	•			z •	- 1	ORA	
ORA	AVM · A A · Ms S-1 · S	100	44	半	00	#	+~	++		48	3 1		++	什		řŤ	+	~	+	+	+	++	广	+	Ĭ	ſ	H	. $ o$	<u> </u>	Ť	\top	7	\Box		•	•	• •	• •		PHA	
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PHY	Y -Ms S-1 ·S	1		1	, ,	1	1	11			3 1		1	1	, 1			- 1			'	11	1	1		Ĺ		.	-	1	.	- 1	1 +					 . z .		PHY PLA	
PLA	S+1 -S Ms -A	 	+	4	\square	+	+	4	+		4 1		+	++	ب	+	+	+	+	+	+	₩	+	十	\vdash	\vdash	+	+	\rightarrow	+	+		H	_	<u> </u>			1 Z (_	PLA	
PLP	S+1 ·S Ms -P					1		11			4 1		1	()	, 1	1		-1			'	10	1	1	1	Ĺ	11	,	J	1	. [ì	1.1	1 1				• Z •	- 1	PLX	- 1
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SBC	A-M-Č -A (3)	Es	3 2	2	ED	4 3	, E:	5 3	2	20	2 1		1 61	2	F3 	15/	2 /	F5	,4 ²	2 FD	14	31	"	′["	3		11	(+21	1,	4	1	11	. .				• 2 (SEC	
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STX	x - M	-	- '	11	ВΕ	4 3	3 8	36 3	2	, 1			1	1	('	11			1			'	1				11	1)	\prod		96	3 4	2	•	•	•	• •	•	STX	
STY	Y - M	1	\perp	\perp	8C	4 3	3 8	34 3	2	لــا	4	\perp	1	H	—'	\downarrow	_	94		_	+,	Ť	+	+	+	+-	4	+		₩	++		₩	4:	•	÷	÷	<u></u>	+	STY	_
STZ	00 · M	7		[}	9C	4 3	3 6	64 3		لي			1	1	1 '	11		74	4 2	. 9⊦	E 5	13		1	1	1	1	1	- 1	1	1	, ,	1				:	• z		STZ	
TAX	A · X	1		11	t	11		'	11	AAI	2 1		- '	1	1	1	.	J	$i \perp$			1	1		1			1	,	1	+1	, ,	1	1 1	٠.			• Z		TAY	
TAY	A · Y AAM · M (6)	.			110	6 3	٠ .	14 5		Ab	12]			1	İ	11	.	ļ	i			1					1			1		i	'	11.	• •		•	• Z		TRB	3
TRB	ĀΛM · M (6) AVM · M (6)					6 3		04 5		i _!	\Box		L	U	1_		, 1	ال	\Box		1	L	L	1	T	L	1	\Box	'	Ш	Ш		L'	Ц.	• •	•		• Z	4	TSB	
TSX	S · X	+	+	1	È	Π	Τ			ВА	2 1	1	T	\Box	\Box	\Box	T.		П	T	T	T	T	T	T	T	7	\bigcap		1	$\tilde{\Box}$	1	1	1	۱.	•	•	• Z		TSX	
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TXS	x ·s	1		11	Ĺ				\downarrow			1		1	1	U	i I	- 1			1			1			1	$1 \cdot 1$		1		i	'	$ \cdot $,	٠.		•	• z		TXS	- 1
AYT	Y - A	丄	\perp	نــــــــــــــــــــــــــــــــــــــ	<u> </u>	Ш		Щ.	ىل	98	[2]	<u>-</u>	ㅗ	ىد	Щ	ш	4			丄	ㅗ		_		1		ىد	44		ப	щ	_	щ	نك	<u> </u>	<u> </u>	_	-		1.155	
Notes																			¥	Inc	ide:	x X										+	Add	đ			r	n No	0 0	Ovcles	

- 1 Add 1 to "n" if page boundary is crossed, except STA and STZ
- 2 Add 1 to "n" if branch occurs to same page. Add 2 to "n" if branch occurs to different page.
- 3 Add 1 to "n" if decimal mode.
- 4 Accumulator address is included in Implied address
- 5 "N" and "V" flags are unchanged in immediate mode
- 6 Z flag indicates AAM result (same as BIT instruction)

- X Index X
- A Accumulator
- M Memory per effective address
- Ms. Memory per stack pointer
- + Add
- n No. Cycles - Subtract # No Bytes

Me Memory Bit #6

M · Memory Bit #7

- Λ And V Or
- ¥- Exclusive or



Enhanced Operational Characteristics

The CMD G65SCXXX family of microprocessors is a complete series of devices designed for building state-of-the-art microcomputer systems. Each member of the family is carefully designed to be hardware compatible, utilize the same basic software instruction set, and to be bus compatible with MC6800 product line. Accordingly, the G65SCXX series is pin compatible with

existing NMOS 6500 type microprocessors.

However, as stated previously, the CMOS design allows several operational enhancements to be incorporated in the current product. These operational enhancementse are explained in Table V.

Table V. Microprocessor Operational Enhancements

Function	NMOS 6500 Microprocessor	1	XX Family processor	
Indexed addressing across page boundary.	Extra read of invalid address.	Extra read of last instr	action byte.	
Execution of invalid op codes.	Some terminate only by reset. Results are	All are NOPs (reserved	for future us	se).
	undefined.	Op Code X2 X3, X7, XB, XF	Bytes 2 1	Cycles 2 1
		44 54, D4, F4 5C DC, FC	2 2 3 3	3 4 8 4
Jump indirect, operand = XXFF.	Page address does not increment.	Page address increme	nts, one addi	itional cycle
Read/modify/write instructions at effective address.	One read and two write cycles.	Two read and one writ	e cycle.	.,,
Decimal flag.	Indeterminate after reset.	Initialized to binary me interrupts.	ode (D=0) aft	er reset and
Flags after decimal operation.	Invalid N, V and Z flags.	Valid flags. One additi	onal cycle.	
Interrupt after fetch of BRK instruction.	Interrupt vector is loaded; BRK vector is ignored.	BRK is executed, then	interrupt is e	executed.
Reset	Reads three stack locations.	Writes program count to stack	ter and status	register
Read/Modify/Write instructions absolute indexed in same page.	Seven cycles.	Six cycles.		

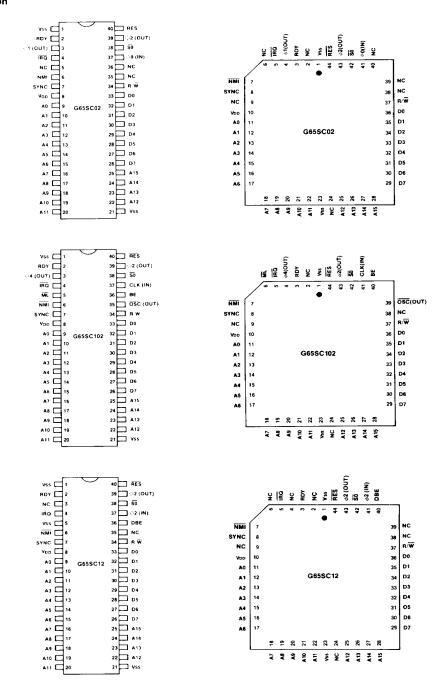
Pin Function

Pin	Description	_
A0-Axx	Address Bus	
BE	Bus Enable	
CLK (IN)	Clock Input	
φ0(I N)	Phase 0 In	
φ2(IN)	Phase 2 In	
DBE	Data Bus Enable	
D0-D7	Data Bus	
ĪRQ	Interrupt Request	
ML	Memory Lock	
NC	No Connection	
NMI	Non-Maskable Interrupt	

Pin	Description
OSC (OUT)	Oscillator Output
φ1(OUT)	Phase 1 Out
φ2(OUT)	Phase 2 Out
φ4(OUT)	Phase 4 Out
RDY	Ready
RES	Reset
R/₩	Read/Write
SO	Set Overflow
SYNC	Synchronize
VDD	Positive Power Supply (+5.0 Volts)
Vss	Internal Logic Ground

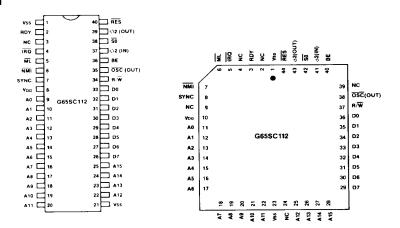


Pin Configuration





Pin Configuration, Continued



Ordering Information

